# **IGBT - Field Stop, Trench**

### 75 A, 650 V

## FGHL75T65LQDT

### **Description**

Field stop 4th generation Low Vce(sat) IGBT technology and Full current rated copak Diode technology.

#### **Features**

- Maximum Junction Temperature:  $T_J = 175^{\circ}C$
- Positive Temperature Co-efficient for Easy Parallel Operating
- High Current Capability
- Low Saturation Voltage:  $V_{CE(Sat)} = 1.15 \text{ V (Typ.)} @ I_C = 75 \text{ A}$
- 100% Of The Part Are Tested For I<sub>LM</sub> (Note 2)
- Smooth & Optimized Switching
- Tight Parameter Distribution
- Co-Packed With Soft And Fast Recovery Diode
- RoHS Compliant

### **Typical Applications**

- Solar Inverter
- UPS, ESS
- PFC, Converters

### **MAXIMUM RATINGS**

Parameter	Symbol	Value	Unit
Collector to Emitter Voltage	V <sub>CES</sub>	650	V
Gate to Emitter Voltage	V <sub>GES</sub>	±20	V
Transient Gate to Emitter Voltage		±30	
Collector Current @ T <sub>C</sub> = 25°C (Note 1)	I <sub>C</sub>	80	Α
Collector Current @ T <sub>C</sub> = 100°C		75	
Pulsed Collector Current (Note 2)	I <sub>LM</sub>	300	Α
Pulsed Collector Current (Note 3)	I <sub>CM</sub>	300	Α
Diode Forward Current @ T <sub>C</sub> = 25°C (Note 1)	Ι <sub>F</sub>	80	Α
Diode Forward Current @ T <sub>C</sub> = 100°C		75	
Pulsed Diode Maximum Forward Current	I <sub>FM</sub>	300	Α
Maximum Power Dissipation @ T <sub>C</sub> = 25°C	$P_{D}$	469	W
Maximum Power Dissipation @ T <sub>C</sub> = 100°C	1	234	
Operating Junction Temperature / Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +175	°C
Maximum Lead Temp. For soldering Purposes, 1/8" from case for 5 seconds	TL	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

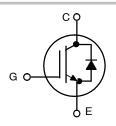
- 1. Value limit by bond wire.
- 2.  $V_{CC}$  = 400 V,  $V_{GE}$  = 15 V,  $I_{C}$  = 300 A, Inductive Load, 100% Tested. 3. Repetitive rating: pulse width limited by max. Junction temperature.

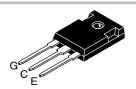


### ON Semiconductor®

#### www.onsemi.com

V <sub>CES</sub>	lc	V <sub>CE(Sat)</sub>
650 V	75 A	1.15 V





TO-247-3L CASE 340CX

### **MARKING DIAGRAM**



= ON Semiconductor Logo \$Y &Z = Assembly Plant Code &3 = 3-Digit Data Code = 2-Digit Lot Traceability Code

FGHL75T65LQDT = Specific Device Code

### **ORDERING INFORMATION**

Device	Package	Shipping
FGHL75T65LQDT	TO-247-3L	30 Units / Rail

### THERMAL CHARACTERISTICS

Parameter	Symbol	Value	Units
Thermal Resistance Junction to Case, for IGBT	$R_{ heta JC}$	0.32	°C/W
Thermal Resistance Junction to Case, for Diode	$R_{ heta JC}$	0.6	°C/W
Thermal Resistance Junction to Ambient	$R_{ heta JA}$	40	°C/W

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS			•		•	
Collector-emitter Breakdown Voltage, Gate-emitter Short-circuited	V <sub>GE</sub> = 0 V, I <sub>C</sub> = 1mA	BV <sub>CES</sub>	650	-	-	V
Temperature Coefficient of Breakdown Voltage	V <sub>GE</sub> = 0 V, I <sub>C</sub> = 1mA	$\Delta BV_CES \ / \Delta T_J$	_	0.6	-	V/°C
Collector-emitter Cut-off Current, Gate-emitter Short-circuited	V <sub>GE</sub> = 0 V, V <sub>CE</sub> = 650 V	I <sub>CES</sub>	-	_	250	μΑ
Gate Leakage Current, Collector-emitter Short-circuited	V <sub>GE</sub> = 20 V, V <sub>CE</sub> = 0 V	I <sub>GES</sub>	-	-	±400	nA
ON CHARACTERISTICS				.1	I	
Gate-emitter Threshold Voltage	$V_{GE} = V_{CE}$ , $I_C = 75 \text{ mA}$	V <sub>GE(th)</sub>	3.0	4.5	6.0	V
Collector-emitter Saturation Voltage	V <sub>GE</sub> = 15 V, I <sub>C</sub> = 75 A, T <sub>J</sub> = 25°C	V <sub>CE(sat)</sub>	-	1.15	1.35	V
	V <sub>GE</sub> = 15 V, I <sub>C</sub> = 75 A, T <sub>J</sub> = 175°C		-	1.22	_	1
DYNAMIC CHARACTERISTICS					1	
Input Capacitance	V <sub>CE</sub> = 30 V, V <sub>GE</sub> = 0 V, f = 1 MHz	C <sub>ies</sub>	_	15300	_	pF
Output Capacitance	1	C <sub>oes</sub>	_	181	_	
Reverse Transfer Capacitance	1	C <sub>res</sub>	_	68	_	
Gate Charge Total	V <sub>CE</sub> = 400 V, I <sub>C</sub> = 75 A, V <sub>GE</sub> = 15 V	Qg	_	793	_	nC
Gate to Emitter Charge	1	Q <sub>ge</sub>	_	72	_	
Gate to Collector Charge	1	Q <sub>gc</sub>	_	248	_	
SWITCHING CHARACTERISTICS, INDUCT	IVE LOAD				-	
Turn-on Delay Time	T <sub>J</sub> = 25°C	t <sub>d(on)</sub>	_	45	_	ns
Rise Time	$V_{CC} = 400 \text{ V}, I_{C} = 37.5 \text{ A}$ Rg = 4.7 $\Omega$	t <sub>r</sub>	-	20	_	1
Turn-off Delay Time	V <sub>GE</sub> = 15 V	t <sub>d(off)</sub>	-	608	_	
Fall Time	7	t <sub>f</sub>	-	160	_	
Turn-on Switching Loss	7	E <sub>on</sub>	-	0.78	_	mJ
Turn-off Switching Loss	7	E <sub>off</sub>	_	1.36	_	1
Total Switching Loss	7	E <sub>ts</sub>	-	2.14	_	
Turn-on Delay Time	T <sub>J</sub> = 25°C V <sub>CC</sub> = 400 V, I <sub>C</sub> = 75 A	t <sub>d(on)</sub>	-	48	_	ns
Rise Time	$Rg = 4.7 \Omega$	t <sub>r</sub>	-	40	_	
Turn-off Delay Time	V <sub>GE</sub> = 15 V	t <sub>d(off)</sub>	-	568	-	1
Fall Time	1	t <sub>f</sub>	-	128	-	1
Turn-on Switching Loss	1	E <sub>on</sub>	-	1.88	-	mJ
Turn-off Switching Loss	1	E <sub>off</sub>	-	2.38	-	1
Total Switching Loss	7	E <sub>ts</sub>	_	4.26	_	1

### **ELECTRICAL CHARACTERISTICS** ( $T_J = 25^{\circ}C$ unless otherwise noted) (continued)

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
SWITCHING CHARACTERISTICS, INDI	UCTIVE LOAD	•		•		•
Turn-on Delay Time	T <sub>J</sub> = 175°C	t <sub>d(on)</sub>	_	44	_	ns
Rise Time	$V_{CC} = 400 \text{ V, I}_{C} = 37.5 \text{ A}$ $Rg = 4.7 \Omega$	t <sub>r</sub>	-	24	-	1
Turn-off Delay Time	V <sub>GE</sub> = 15 V	t <sub>d(off)</sub>	-	680	-	1
Fall Time		t <sub>f</sub>	-	256	_	1
Turn-on Switching Loss		E <sub>on</sub>	-	1.54	-	mJ
Turn-off Switching Loss		E <sub>off</sub>	_	2.11	_	
Total Switching Loss		E <sub>ts</sub>	-	3.65	_	1
Turn-on Delay Time	T <sub>J</sub> = 175°C	t <sub>d(on)</sub>	-	44	-	ns
Rise Time	$V_{CC} = 400 \text{ V, I}_{C} = 75 \text{ A}$ Rg = 4.7 $\Omega$	t <sub>r</sub>	-	44	-	1
Turn-off Delay Time	V <sub>GE</sub> = 15 V	t <sub>d(off)</sub>	-	632	-	1
Fall Time		t <sub>f</sub>	-	184	-	1
Turn-on Switching Loss		E <sub>on</sub>	-	3.14	-	mJ
Turn-off Switching Loss		E <sub>off</sub>	-	3.58	_	
Total Switching Loss		E <sub>ts</sub>	-	6.72	_	
DIODE CHARACTERISTICS						
Diode Forward Voltage	I <sub>F</sub> = 75 A, T <sub>J</sub> = 25°C	V <sub>F</sub>	-	1.65	2.1	V
	I <sub>F</sub> = 75 A, T <sub>J</sub> = 175°C		_	1.55	-	
Reverse Recovery Energy	T <sub>J</sub> = 25°C,	Erec	-	105	-	μJ
Reverse Recovery Time	V <sub>R</sub> = 400 V, I <sub>F</sub> = 37.5 A, di <sub>F</sub> /dt = 1000 A/μs	Trr	-	59	-	ns
Reverse Recovery Charge		Qrr	-	574	-	nC
Reverse Recovery Current		Irr	-	20	-	Α
Reverse Recovery Energy	T <sub>J</sub> = 25°C,	Erec	-	152	-	μJ
Reverse Recovery Time	V <sub>R</sub> = 400 V, I <sub>F</sub> = 75 A, di <sub>F</sub> /dt = 1000 A/μs	Trr	-	87	-	ns
Reverse Recovery Charge		Qrr	-	794	-	nC
Reverse Recovery Current		Irr	_	18	_	Α
Reverse Recovery Energy	T <sub>J</sub> = 175°C,	Erec	-	550	-	μJ
Reverse Recovery Time	V <sub>R</sub> = 400 V, I <sub>F</sub> = 37.5 A, di <sub>F</sub> /dt = 1000 A/μs	Trr	-	119	-	ns
Reverse Recovery Charge		Qrr	_	2154	_	nC
Reverse Recovery Current		Irr	-	36	-	Α
Reverse Recovery Energy	T <sub>J</sub> = 175°C,	Erec	_	764	_	μJ
Reverse Recovery Time	V <sub>R</sub> = 400 V, I <sub>F</sub> = 75 A, di <sub>F</sub> /dt = 1000 A/μs	Trr	-	145	-	ns
Reverse Recovery Charge		Qrr	_	2947	_	nC
Reverse Recovery Current		Irr	-	40	-	Α

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

### **TYPICAL CHARACTERISTICS**

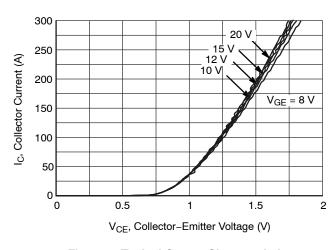


Figure 1. Typical Output Characteristics  $(T_J = 25^{\circ}C)$ 

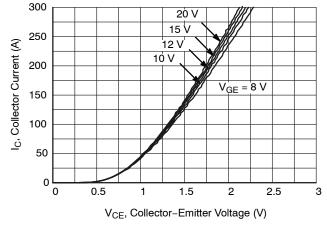


Figure 2. Typical Output Characteristics  $(T_J = 175^{\circ}C)$ 

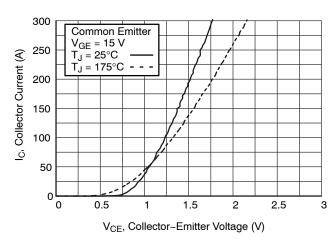


Figure 3. Typical Saturation Voltage Characteristics

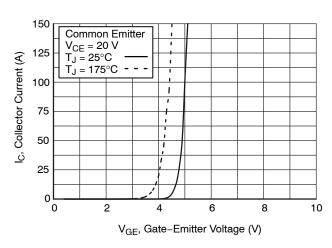


Figure 4. Typical Transfer Characteristics

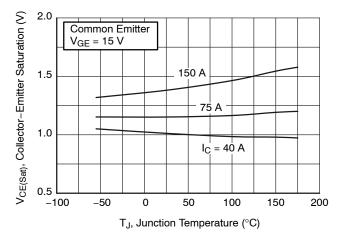


Figure 5. Saturation Voltage vs. Junction Temperature

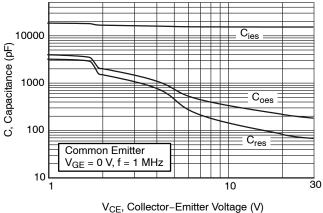
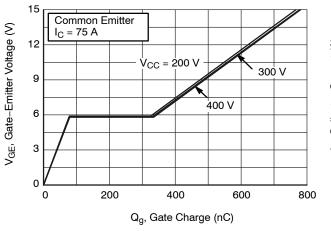


Figure 6. Capacitance Characteristics

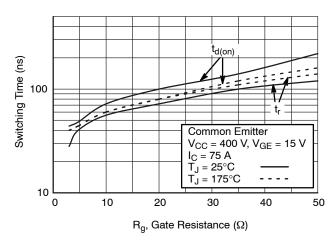
### TYPICAL CHARACTERISTICS (continued)



1000 DC 10 μs 10

Figure 7. Gate Charge Characteristics

Figure 8. SOA Characteristics



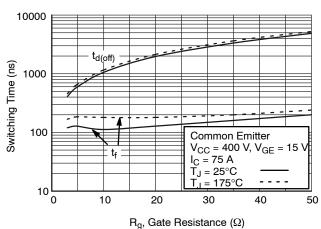
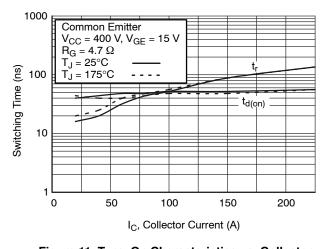


Figure 9. Turn-On Characteristics vs. Gate Resistance

Figure 10. Turn-Off Characteristics vs. Gate Resistance



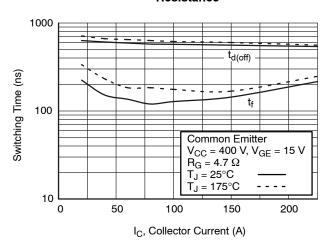


Figure 11. Turn-On Characteristics vs. Collector Current

Figure 12. Turn-Off Characteristics vs. Collector Current

### TYPICAL CHARACTERISTICS (continued)

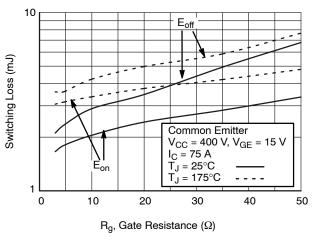


Figure 13. Switching Loss vs. Gate Resistance

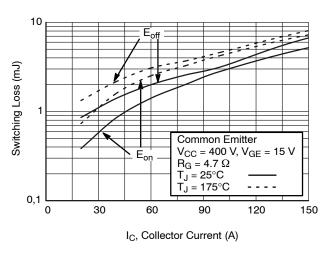


Figure 14. Switching Loss vs. Collector Current

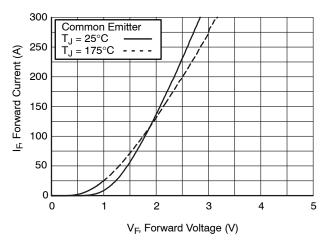
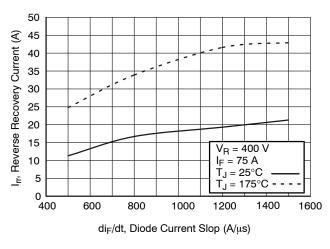


Figure 15. Forward Characteristics



**Figure 16. Reverse Recovery Current** 

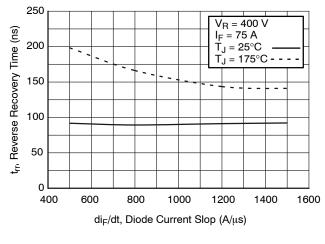


Figure 17. Reverse Recovery Time

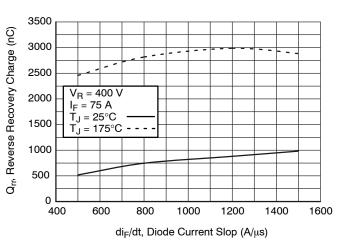


Figure 18. Stored Charge

### TYPICAL PERFORMANCE CHARACTERISTICS (continued)

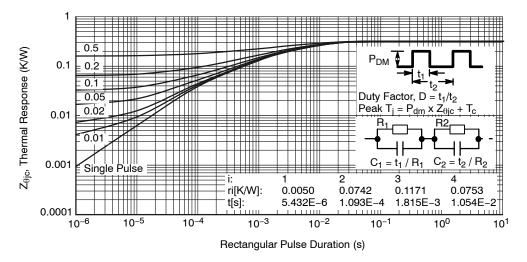


Figure 19. Transient Thermal Impedance of IGBT

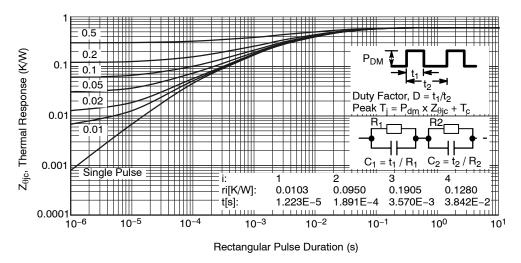
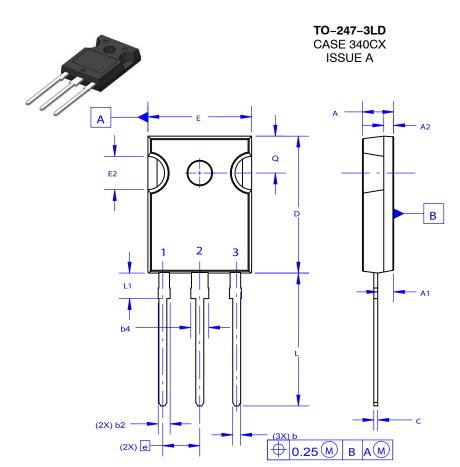


Figure 20. Transient Thermal Impedance of Diode

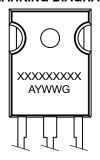
**DATE 06 JUL 2020** 



NOTES: UNLESS OTHERWISE SPECIFIED.

- A. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- B. ALL DIMENSIONS ARE IN MILLIMETERS.
- C. DRAWING CONFORMS TO ASME Y14.5 2009.
- D. DIMENSION A1 TO BE MEASURED IN THE REGION DEFINED BY L1.
- E. LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY L1.

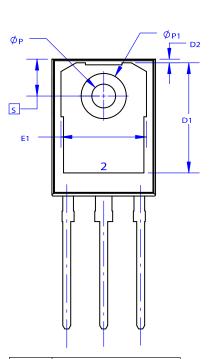
# GENERIC MARKING DIAGRAM\*



XXXXX = Specific Device Code A = Assembly Location

Y = Year WW = Work Week G = Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " •", may or may not be present. Some products may not follow the Generic Marking.



DIM	MILLIMETERS			
DIM	MIN	NOM	MAX	
Α	4.58	4.70	4.82	
<b>A</b> 1	2.20	2.40	2.60	
A2	1.40	1.50	1.60	
D	20.32	20.57	20.82	
E	15.37	15.62	15.87	
E2	4.96	5.08	5.20	
е	~	5.56	~	
L	19.75	20.00	20.25	
L1	3.69	3.81	3.93	
ØΡ	3.51	3.58	3.65	
Q	5.34	5.46	5.58	
S	5.34	5.46	5.58	
b	1.17	1.26	1.35	
b2	1.53	1.65	1.77	
b4	2.42	2.54	2.66	
С	0.51	0.61	0.71	
D1	13.08	~	~	
D2	0.51	0.93	1.35	
E1	12.81	~	~	
ØP1	6.60	6.80	7.00	

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AFGY160T65SPD-B4 IGW30N60TP IGW40N60TP IGW50N60TP IHW30N65R5 IKFW40N60DH3E IKP15N65H5 IKQ100N60T

IKQ120N60T IKW30N65WR5 IKW75N60H3 IKZ50N65NH5 IKZ75N65NH5 FGD3040G2-F085C FGH4L50T65SQD FGHL40T65MQDT

FGHL50T65MQD FGHL50T65MQDTL4 FGHL75T65LQDT FGHL75T65MQD FGHL75T65MQDT FGHL75T65MQDTL4

FGY75T120SWD EL3120S1(TA)(SAS)-V IHW15N120E1 IKQ75N120CS6 IKW50N65WR5 SL15T65FK KGF50N65KDF-U/H

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